

General Description

The SJP40P185 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

Features

- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	-40	V
R _{DS(ON)_TYP}	19.7	mΩ
ID	-8.1	А
Q _G	25	nC



Schematic Diagram

SOP-8 top&bottom view

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJP40P185	SJP40P185	SOP-8	Таре	/	١	4000 Pcs

Table 1. Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	-40	V
Vgs	Gate-Source Voltage (V _{DS} =0V)	±20	V
1	Drain Current-Continuous(T _A =25℃)	-8.1	А
ID	Drain Current-Continuous(T _A =100°C)	-5.1	А
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-32.4	А
P	Maximum Power Dissipation(T _A =25°C)	2.9	W
PD	Maximum Power Dissipation(T _A =100°C)	1.2	W
Eas	Avalanche energy (Note 2)	100	mJ
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
R _{θJA}	Thermal Resistance, Junction-to-Ambient		43	°C/W



Table 3. Electrical Characteristics (T_J=25 $^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States	-					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250µA	-40			V
		V _{DS} =-40V, V _{GS} =0V TJ=25℃			-1	μA
IDSS	Zero Gate Voltage Drain Current	V _{DS} =-40V, V _{GS} =0V T _J =125℃			-100	μA
lgss	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250µA	-1		-2.5	V
g fs	Forward Transconductance	V _{DS} =-5V, I _D =-5A		33		S
Rds(on)	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-5A T _J =25℃		19.7	25.6	mΩ
Rds(on)	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-4A T _J =25℃		24.6	32.7	mΩ
Dynamic Chara	acteristics					
Ciss	Input Capacitance			1420		pF
Coss	Output Capacitance	V _{DS} =-20V,V _{GS} =0V, f=1.0MHz		129		pF
Crss	Reverse Transfer Capacitance			87		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		10		Ω
Switching Para	meters					
t _{d(on)}	Turn-on Delay Time			7.5		nS
tr	Turn-on Rise Time	V _{GS} =-10V, V _{DS} =-20V,		4		nS
t _{d(off)}	Turn-Off Delay Time	$R_L=4\Omega$, $R_{GEN}=3\Omega$		30		nS
t _f	Turn-Off Fall Time			6		nS
Qg	Total Gate Charge			25		nC
Q _{gs}	Gate-Source Charge	V _{GS} =-10V, V _{DS} =-20V, I _D =-5A		6.5		nC
Q_gd	Gate-Drain Charge			3.5		nC
Source-Drain D	Diode Characteristics					
I _{SD}	Source-Drain Current (Body Diode)				-8.1	Α
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =-5A			1.2	V
t _{rr}	Reverse Recovery Time	I⊧=-5A, dI/dt=100A/μs		36		ns
Qrr	Reverse Recovery Charge	I⊧=-5A, dI/dt=100A/μs		40		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=-40V$, $V_G=10V$, $Rg=25\Omega$, L=0.5mH.

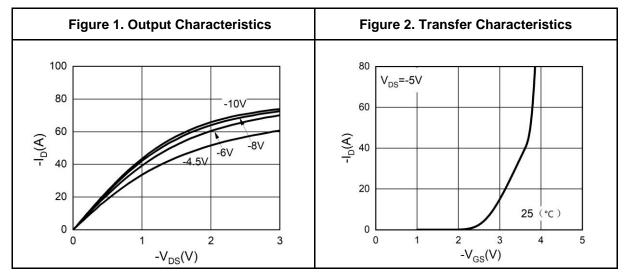
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

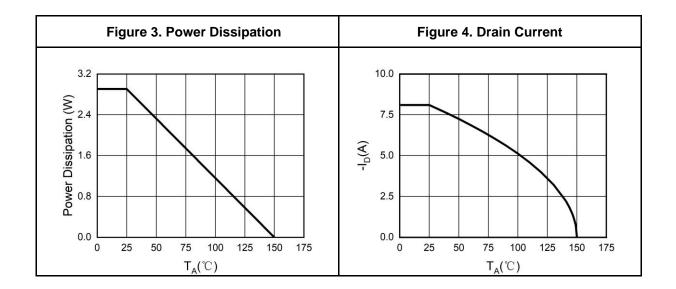


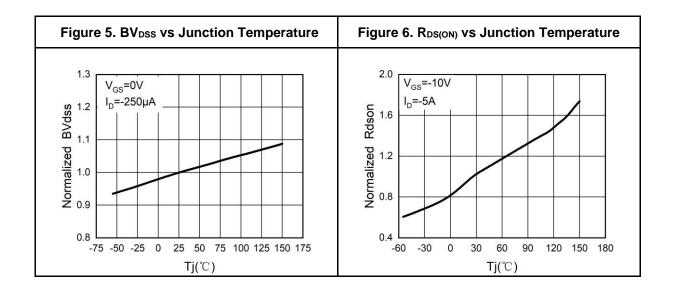
SJP40P185

40V P-Channel Trench Power MOSFET

Typical Electrical And Thermal Characteristics (Curves)



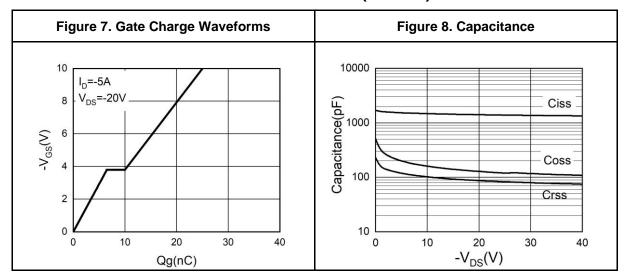


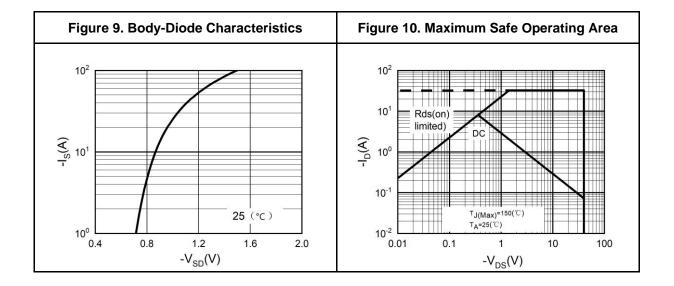




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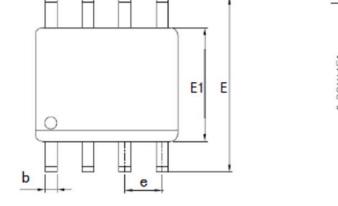


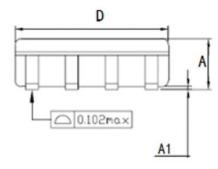


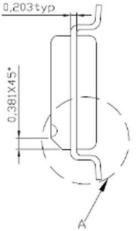
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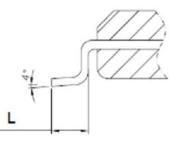
40V P-Channel Trench Power MOSFET

SOP-8 Package Information









A 局部放大

	Dime isions In Millimeters				
Symbol	Min.	Nom.	Мах		
А	1.35	1.55	1.75		
A1	0.1	0.15	0.2		
b	0.346	0.406	0.466		
D	4.8	4.89	4.98		
E	5.75	6.00	6.25		
E1	3.81	3.90	3.99		
е	1.27TYP				
L	0.406	0.838	1.27		



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